FCL Components Wireless Modules

Bluetooth® Version 5.0 Central/Peripheral with Blank Firmware FWM7BLZ20B-109077

Overview

Bluetooth*

Compact Bluetooth Version 5.0 (low energy single mode) module includes SoftDevice (Bluetooth stack) only, works as Central/Peripheral with customer's own firmware.

RoHS compliant

Features

- User can construct firmware which embeds "X2 speed" and "LE Advertising Extensions" freely with the tool provided by Nordic Semiconductor.
- Out-of-Band pairing by use of NFC-A Tag Interface (external antenna is necessary).
- It corresponds maximum 255 bytes long packet.
- Good for IoT-related devices or its maintenance.



FWM7BLZ20B-109077

Evaluation board

Part number	Details	
FWM7BLZ20B-EVB-EB1	Evaluation board (FWM7BLZ20B-109077 x 1 is mounted)	
■ SoftDevice version		
Part number	SoftDevice version	
FWM7BLZ720B-109077	S132Ver.6.1.1	

■ Upper protocol/application development tool

Software Development Kit (SDK):

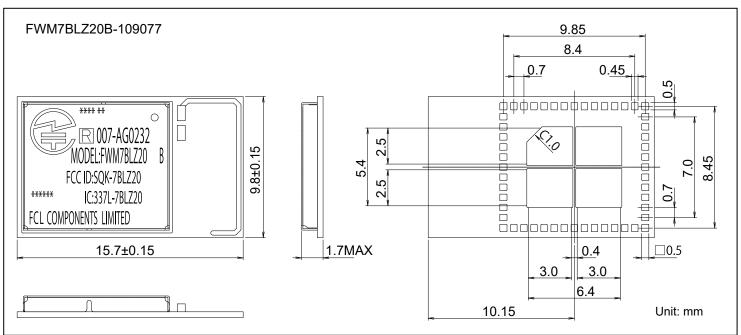
Please download from Nordic Semiconductor ASA website: www.nordicsemi.com

Specifications

Item	Specifications			
Part number	FWM7BLZ20B-109077			
Antenna	Embedded (Pattern antenna)			
Bluetooth technology	Conforms to Bluetooth Core Specification Version 5.0 technology (Low energy singel mode)			
Other communication	NFC (requires external antenna)			
RAM	64Kbytes			
ROM	512Kbytes			
Transmit power	+4 dBm max.			
Receiver sensitivity	-94 dBm typical			
Interface	NFC (via external antenna), UART, GPIO, SWDCLK, SWDIO, nRESET, SPI, TWI, ADC			
Crystal oscillator	Embedded			
Operating voltage	1.7V to 3.6VDC			
Symbol rate	1Mbps / 2Mbps (depends on communication partner)			
Data rate	1Mbps / 2Mbps (depends on communication partner)			
Advertising size	225 bytes			
IC tip	nRF52832 (Nordic Semiconductor)			
Power consumption	Tx mode	LDO mode: 11.6mA typical (at 0dBm), DC/DC mode: 5.3mA typical (at 0dBm)		
	Rx mode	LDO mode: 11.7mA typical (at data rate 1Mbps), 12.9mA typical (at data rate 2Mbps) DC/DC mode: 5.4mA typical (at data rate 1Mbps), 5.8mA typical (at data rate 2Mbps)		
Operating temperature		-40°C to +85°C		
Dimensions		15.7 x 9.8 x 1.7mm		
Mounting method		Surface mount (SMT)		
Certifications		Bluetooth qualification (QDID)*1, Radio Act (Japan), FCC, IC, CE		

Note: *1: Bluetooth SIG registration is required to use modules QDID

Dimensions



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